Quad 2-input multiplexer with 5 V tolerant inputs/outputs; 3-state

Rev. 6 — 28 November 2011

**Product data sheet** 

### 1. General description

The 74LVC257A is a quad 2-input multiplexer with 3-state outputs, which select 4 bits of data from two sources and are controlled by a common data select input (pin S). The data inputs from source 0 (pins 1I0 to 4I0) are selected when pin S is LOW and the data inputs from source 1 (pins 1I1 to 4I1) are selected when pin S is HIGH. Data appears at the outputs (pins 1Y to 4Y) in true (non-inverting) form from the selected inputs. The device is the logic implementation of a 4-pole, 2-position switch, where the position of the switch is determined by the logic levels applied to pin S. The outputs are forced to a high-impedance OFF-state when pin OE is HIGH.

Inputs can be driven from either 3.3 V or 5.0 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

### 2. Features and benefits

- 5 V tolerant inputs/outputs, for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Output drive capability 50 Ω transmission lines at 85 °C
- Complies with JEDEC standard:
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

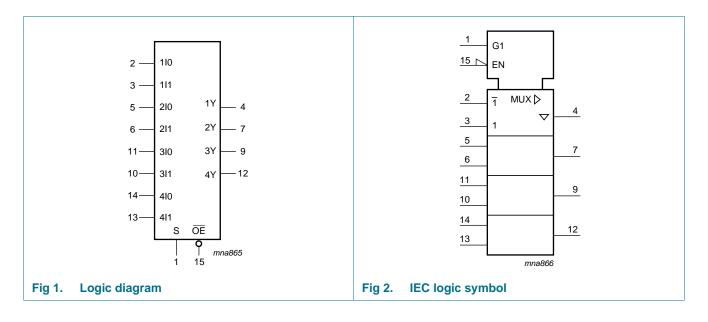


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## 3. Ordering information

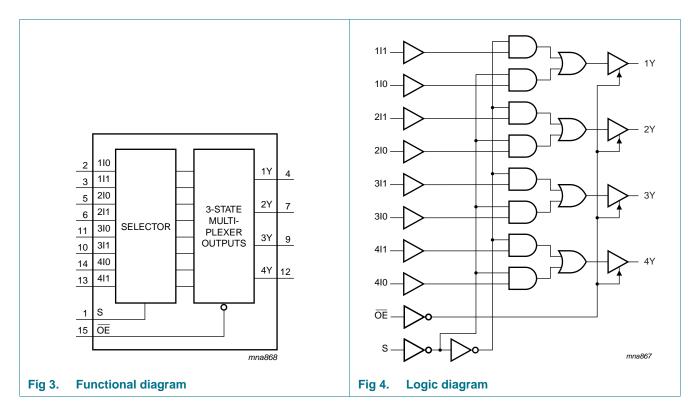
Type number	Package								
	Temperature range	Name	Description	Version					
74LVC257AD	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74LVC257ADB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-					
74LVC257APW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-7					
74LVC257ABQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-					

## 4. Functional diagram

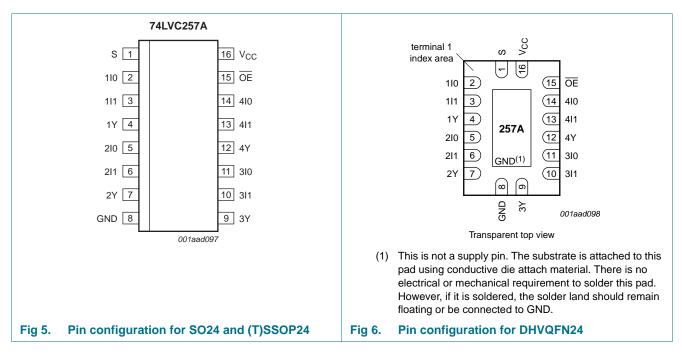


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### 5. Pinning information



### 5.1 Pinning

Quad 2-input multiplexer with 5V tolerant; 3-state

## 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
S	1	common data select input
110	2	data input from source 0
111	3	data input from source 1
1Y	4	3-state multiplexer output
210	5	data input from source 0
211	6	data input from source 1
2Y	7	3-state multiplexer output
GND	8	ground (0 V)
3Y	9	3-state multiplexer output
311	10	data input from source 1
310	11	data input from source 0
4Y	12	3-state multiplexer output
411	13	data input from source 1
410	14	data input from source 0
OE	15	3-state output enable input (active LOW)
V <sub>CC</sub>	16	supply voltage

## 6. Functional description

#### Table 3. Function table<sup>[1]</sup>

Input OE	Output			
OE	S	nl0	nl1	nY
Н	Х	Х	X	Z
L	Н	Х	L	L
L	Н	Х	Н	Н
L	L	L	Х	L
L	L	Н	Х	Н

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

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### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
l <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0	-	±50	mA
Vo	output voltage	HIGH or LOW state	[2] -0.5	V <sub>CC</sub> + 0.5	V
		output 3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$	[3] _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	HIGH or LOW state	0	-	V <sub>CC</sub>	V
		3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC}$ = 2.7 V to 3.6 V	0	-	10	ns/V

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### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	<b>−40 °C to +85 °C</b>			–40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Max	Min	Max		
VIH	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V	
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{\text{CC}}$	-	-	$0.65 \times V_{CC}$	-	V	
	$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V		
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V	
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V	
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V	
√ <sub>ОН</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V	
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
V <sub>OL</sub> LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V	
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V	
		$I_0$ = 8 mA; $V_{CC}$ = 2.3 V	-	-	0.6	-	0.8	V	
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V	
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V	
I	input leakage current	$V_{CC}$ = 3.6 V; $V_{I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μA	
oz	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; \ V_{CC} = 3.6 \ V; \\ V_{O} = 5.5 \ V \text{ or } \ GND; \end{array}$	-	±0.1	±5	-	±20	μΑ	
OFF	power-off leakage current	$V_{CC}$ = 0 V; V <sub>1</sub> or V <sub>0</sub> = 5.5 V	-	±0.1	±10	-	±20	μΑ	
СС	supply current	$\label{eq:VCC} \begin{array}{l} V_{CC}=3.6 \ \text{V}; \ \text{V}_{\text{I}}=\text{V}_{CC} \ \text{or GND}; \\ I_{O}=0 \ \text{A} \end{array}$	-	0.1	10	-	40	μA	
∆I <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μΑ	
Cı	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>	-	5.0	-	-	-	pF	

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

Quad 2-input multiplexer with 5V tolerant; 3-state

## **10. Dynamic characteristics**

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	-
pd	propagation delay	nI0, nI1 to nY; see Figure 7	[2]		1	I	1	1	
		V <sub>CC</sub> = 1.2 V		-	16	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.5	5.2	10.6	1.5	12.3	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.8	5.5	1.0	6.4	ns
		$V_{CC} = 2.7 V$		1.0	2.8	5.4	1.0	7.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.4	4.6	1.0	6.0	ns
		S to nY; see Figure 7	[2]						
		V <sub>CC</sub> = 1.2 V		-	18	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.0	6.0	14.8	1.0	17.1	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	3.2	7.7	1.0	8.9	ns
		$V_{CC} = 2.7 V$		1.0	3.2	7.5	1.0	9.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.7	6.4	1.0	8.0	ns
en	enable time	OE to nY; see Figure 8	[2]						
		V <sub>CC</sub> = 1.2 V		-	15	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.5	5.8	12.7	1.5	14.7	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	3.3	7.0	1.5	8.1	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.7	1.5	8.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.7	5.6	1.0	7.0	ns
dis	disable time	OE to nY; see Figure 8	[2]						
		V <sub>CC</sub> = 1.2 V		-	8	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.2	4.0	8.2	2.2	9.4	ns
		$V_{CC}$ = 2.3 V to 2.7 V		0.5	2.2	4.4	0.5	5.1	ns
		$V_{CC} = 2.7 V$		1.5	3.0	4.7	1.5	6.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	2.8	4.3	1.0	5.5	ns
sk(o)	output skew time	$V_{CC}$ = 3.0 V to 3.6 V	[3]	-	-	1.0	-	1.5	ns

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Symbol	Parameter	Conditions		–40 °C to +85 °C		–40 °C to	Unit		
				Min	Typ[1]	Max	Min	Max	
C <sub>PD</sub> power dissipation		per input; $V_I = GND$ to $V_{CC}$	<u>[4]</u>						
capacitance	capacitance	$V_{CC}$ = 1.65 V to 1.95 V		-	8.0	-	-	-	pF
		$V_{CC}$ = 2.3 V to 2.7 V		-	11.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	14.4	-	-	-	pF

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and V<sub>CC</sub> = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

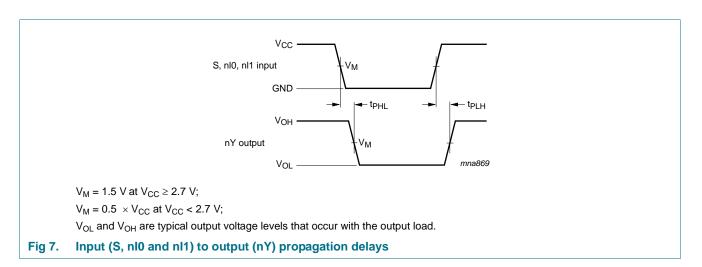
 $C_L$  = output load capacitance in pF

 $V_{CC}$  = supply voltage in Volts

N = number of inputs switching

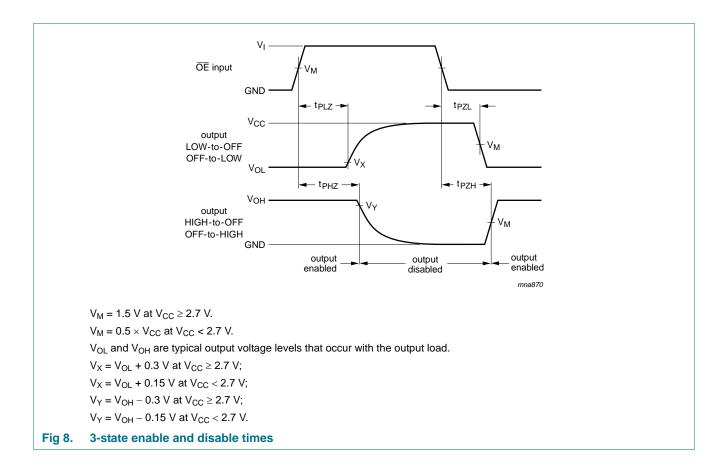
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs

### 11. Waveforms



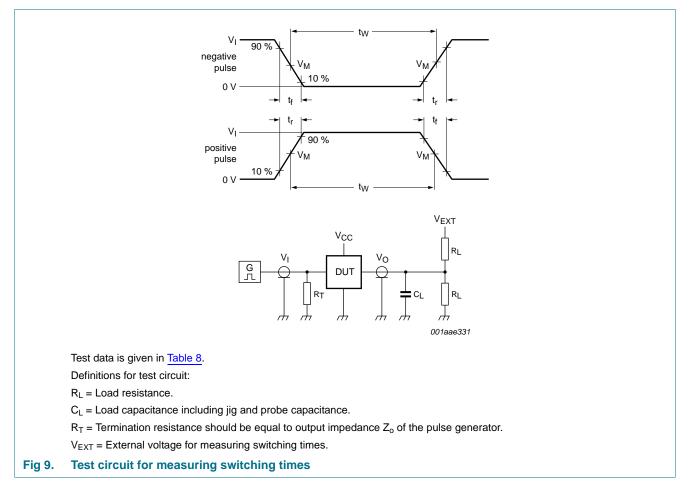
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# 74LVC257A

#### Quad 2-input multiplexer with 5V tolerant; 3-state



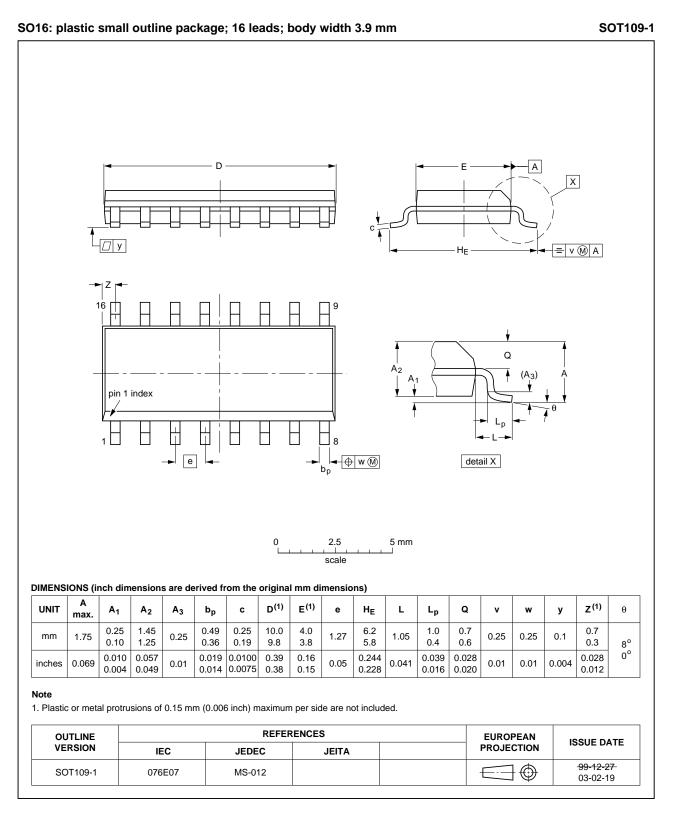
	Tabl	le 8.	Test	data
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Supply voltage	Input	Input		Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

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### 12. Package outline



#### Fig 10. Package outline SOT109-1 (SO16)

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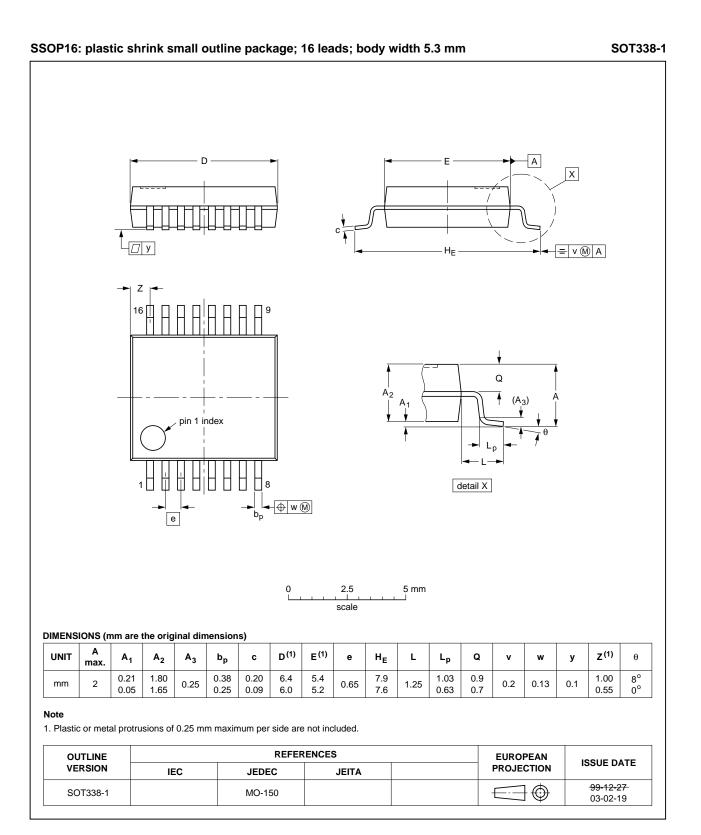
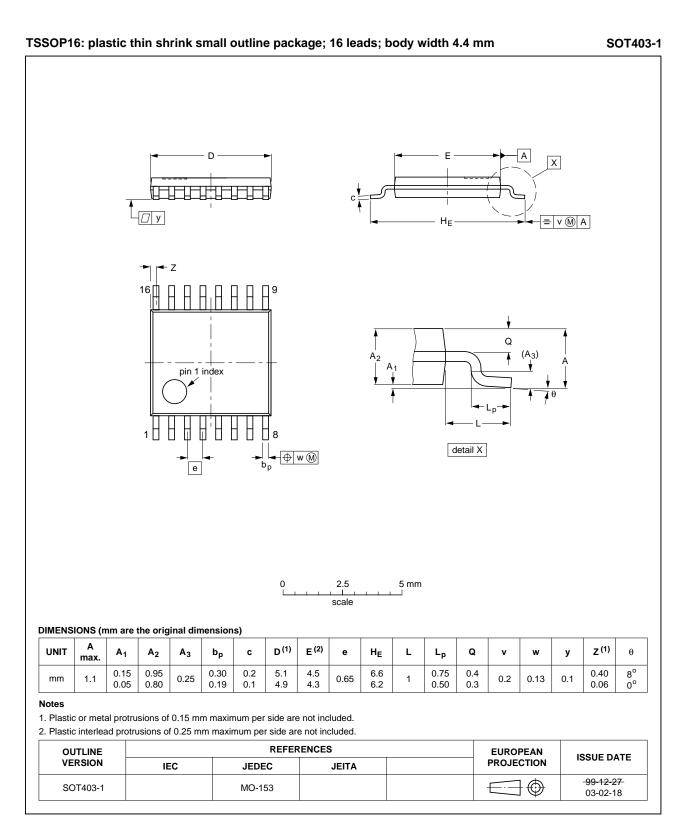


Fig 11. Package outline SOT338-1 (SSOP16)

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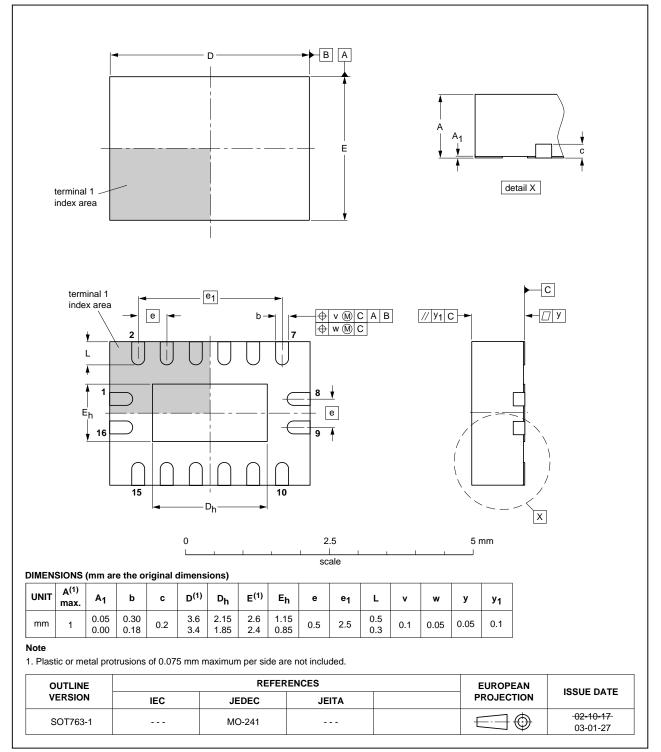
Quad 2-input multiplexer with 5V tolerant; 3-state



#### Fig 12. Package outline SOT403-1 (TSSOP16)

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Quad 2-input multiplexer with 5V tolerant; 3-state



#### DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

#### Fig 13. Package outline SOT763-1 (DHVQFN16)

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Quad 2-input multiplexer with 5V tolerant; 3-state

### **13. Abbreviations**

Table 9.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

## 14. Revision history

Table 10. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC257A v.6	20111128	Product data sheet	-	74LVC257A v.5
Modifications:	<ul><li>Value changes for</li><li>Typographical error</li></ul>	t <sub>pd</sub> , t <sub>en</sub> and t <sub>dis</sub> in <u>Table 7</u> ors corrected	"Dynamic characteristics	1
74LVC257A v.5	20111108	Product data sheet	-	74LVC257A v.4
Modifications:	<ul> <li>The format of this NXP Semiconduct</li> </ul>	document has been redes tors.	igned to comply with the r	new identity guidelines of
	<ul> <li>Legal texts have b</li> </ul>	een adapted to the new c	company name where app	propriate.
	• <u>Table 4, Table 5, T</u>	<u>able 6, Table 7</u> and <u>Table</u>	8: values added for lowe	r voltage ranges.
74LVC257A v.4	040123	Product specification	-	74LVC257A v.3
74LVC257A v.3	031117	Product specification	-	74LVC257A v.2
74LVC257A v.2	980729	Product specification	-	74LVC257A v.1
74LVC257A v.1	-	-	-	-

Quad 2-input multiplexer with 5V tolerant; 3-state

### **15. Legal information**

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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